- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

These devices contain two independent $J-\overline{K}$ positive-edge-triggered flip-flops. A low level at the preset or clear inputs sets or resets the outputs regardless of the levels of the other inputs. When preset and clear are inactive (high), data at the J and \overline{K} inputs meeting the setup time requirements are transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold time interval, data at the J and \overline{K} inputs may be changed without affecting the levels at the outputs. These versatile flip-flops can perform as toggle flip-flops by grounding \overline{K} and tying J high. They also can perform as D-type flip-flops if J and \overline{K} are tied together.

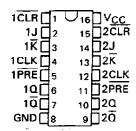
The SN54109 and SN54LS109A are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74109 and SN74LS109A are characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each flip-flop)

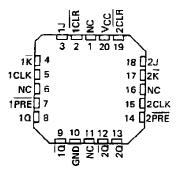
	IN	PUTS			OUT	PUTS
PRE	CLR	CLK	J	K	a	ā
L	Н	X	х	Х	H	L
н	L	×	X	X	L	Н
L	L	X	Х	Х	Нţ	Нţ
Н	н	f	L	L	L	Н
Н	H	t	Н	L	TOGG	GLE
н	Н	Ť	Ł	н	വു	$\overline{\alpha}_0$
н	Н	t	Н	н	Н	L
н	н	L	Х	х	Q ₀	ō₀ ·

 $^{^\}dagger$ The output levels in this configuration are not guaranteed to meet the minimum levels for V_{OH} if the lows at preset and clear are near V_{1L} maximum. Furthermore, this configuration is nonstable; that is, it will not persist when preset or clear return to their inactive (high) level.

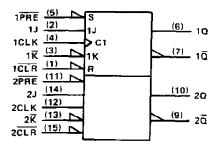
SN54109, SN54LS109A...J OR W PACKAGE SN74109...N PACKAGE SN74LS109A...D OR N PACKAGE (TOP VIEW)



SN54LS109A ... FK PACKAGE (TOP VIEW)



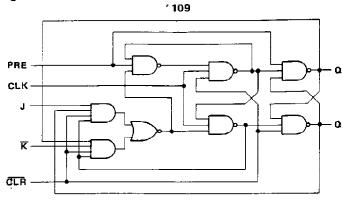
logic symbol‡



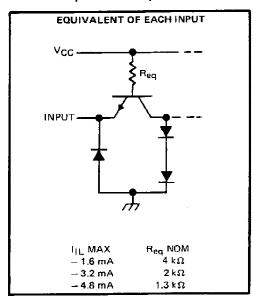
[‡]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

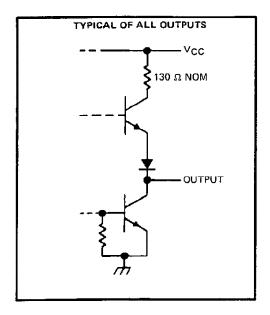
logic diagram (positive logic)

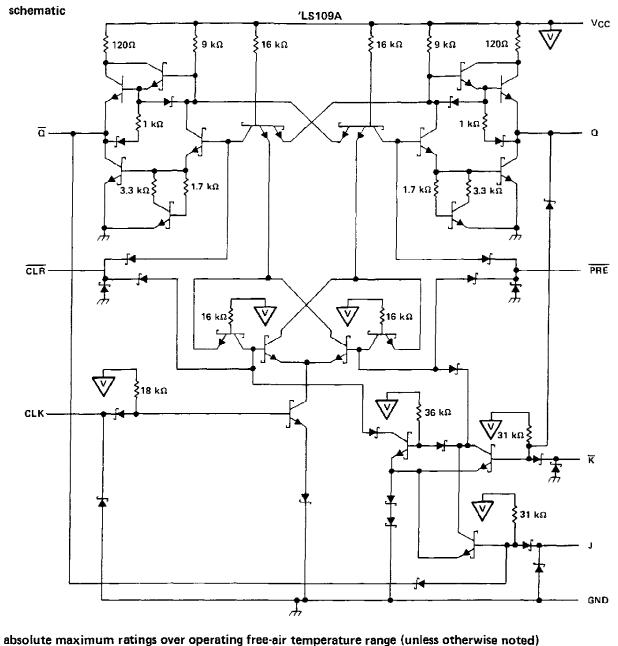


schematics of inputs and outputs



109





Supply voltage, VCC (see Note 1)	***************************************	7 V
Input voltage: '109	<u> </u>	5.5 V
'LS109A		
Operating free-air temperature range:	SN54'	- 55°C to 125°C
·	SN74'	0°C to 70°C
Storage temperature range	***************************************	- 65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



SN54109, SN74109 DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH PRESET AND CLEAR

recommended operating conditions

		-		SN5410	09	1	SN7410)9	UNIT
			MIN	MOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage		2			2			V
٧ıL	Low-level input voltage			.,	8.0			0.8	V
ІОН	High-level output current				- 0.8			- 0.8	mA
IOL	Low-level output current				16			16	mA
	Pulse duration	CLK high or low	20			20			
tw.	Fuise duration	PRE or CLR low	20			20		T	ns
tsu	Input setup time before CLK 1	·	10			10			ns
t _{h_}	Input hold time-data after CLK1		6			6			ns
TΑ	Operating free-air temperature		~ 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PAR.	AMETER		TEST CONDITI	onet		SN5410	9		SN7410	9	
1211	AIVIETEIS !		TEBT CONDITI		MIN	TYP‡	MAX	MIN	TYP‡	MAX	דומט
VIK		V _{CC} = MIN,	= - 12 mA				- 1.5			- 1.5	V
Vон		V _{CC} = MIN, I _{OH} = - 0.8 mA	V _{IH} = 2 V,	V _{IL} ≈ 0.8 V,	2.4	3,4		2.4	3.4		v
VOL		V _{CC} = MIN, I _{OL} = 16 mA	V _{IH} = 2 V,	V _{IL} = 0.8 V,		0.2	0.4		0.2	0.4	٧
11		V _{CC} = MAX,	V _I = 5.5 V				1		·	1	mA
	J or K						40			40	
1	CLR	V _{CC} = MAX,	V. ~ 2.4.V				160			160	_
НІ	PRE or CLK	4GC - MIAA,	v ₁ - 2.4 v				80			80	μА
	Jor \overline{K}						- 1.6			- 1.6	
1	CLR1	V _{CC} = MAX,	V. = 0.4 W				- 4.8			- 4.8	mΑ
'IL	PRE¶	OCC - MAX,	V = 0.4 V				- 3.2			- 3.2	
	CLK		-	<u></u>			- 3.2			-3.2	
los §		V _{CC} = MAX			- 30		- 85	- 30	* ***	- 85	mA
ICC#		V _{CC} = MAX,	See Note 2		T	9	15		9	15	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: With all outputs open. ICC is measured with the Q and Q outputs high in turn. At the time of measurement, the clock input is grounded,

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
fmax				25	33		MHz
tPLH	PRE	Q			10	15	ns
₹₽HL		ā			23	35	ns
^t PLH	CLR	ত্র	$R_L = 400 \Omega$, $C_L = 15 \rho F$		10	15	ns
tpHL	0211	a			17	25	ns
TPLH	CLK	QorQ			10	16	ns
tpHL_	OEK .	4314			18	28	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25 \,^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time.

¹ Clear is tested with preset high and preset is tested with clear high.

[#] Average per flip-flop.

SN54LS109A, SN74LS109A DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH PRESET AND CLEAR

recommended operating conditions

			s	N54LS1	09A	SI	N74LS1	A90	118117
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
v _{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	٧
v_{lH}	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.7			0.8	V
ТОН	High-level output current				- 0.4		••	- 0.4	mA
IOL	Low-level output current				4			8	mA
fclock	Clock frequency		0		25	0		25	MHz
	Dulan dunain	CLK high	25			25	_		
t _w	Pulse duration	PRE or CLR low	25			25			ns
	Beautiful before CLV 4	High-level data	35			35			
t _{su}	Setup time before CLK †	Low-level data	25			25			ns
th	Hold time-data after CLK †		5			5			ns
TA	Operating free-air temperature		- 55	*	125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITION	uet	SN	154LS10)9A	SN	174LS10	9A	
FARAINE I ER	1	TEST CONDITIO	49.	MIN	TYP#	MAX	MIN TYPE MAX		דומט	
Vik	VCC - MIN,	I _I = - 18 mA	-			– 1.5			_ 1.5	V
VOH	V _{CC} = MIN, I _{OH} = - 0.4 mA	V _{IH} = 2 V,	V _{IL} = MAX,	2.5	3.4		2.7	3.4		V
	V _{CC} = MIN, I _{OL} = 4 mA	VIL = MAX,	V _{IH} = 2 V,		0.25	0,4		0.25	0.4	V
VOL	V _{CC} = MIN, I _{OL} = 8 mA	VIL = MAX,	V _{1H} = 2 V,					0.35	0.5	\ \ \
J, K or CLK	Vcc = MAX,	V ₁ = 7 V				0.1			0.1	_^
CLR or PRE	ACC - MINY	- V - Y V				0.2			0.2	mA
J, R or CLK	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	
TH CLR or PRE	7 400 - 14122	V - 2.7 V				40			40	μΑ
J, K or CLK	VCC = MAX,	V _I = 0.4 V				- 0.4			- 0.4	
CLR or PRE	YCC - WAX,	V - 0.4 V				- 0.8			- 0.8	mA
OS§	VCC = MAX,	See Note 4	_	- 20	_	100	- 20		- 100	mA
ICC (Total)	V _{CC} = MAX,	See Note 2			4	8		4	8	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions,

NOTE 2: With all outputs open, ICC is measured with the Q and Q outputs high in turn. At the time of measurement, the clock input is grounded.

NOTE 4: For certain devices where state commutation can be caused by shorting an output to ground, an equivalent test may be performed with V_O = 2.25 V and 2.125 V for the 54 family and the 74 family, respectively with the minimum and maximum limits reduced to one half of their stated values.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	мах	UNIT
f _{max}				25	33		MHz
^t PLH	CLR, PRE	Q or Q	$R_L = 2 k\Omega$, $C_L = 15 pF$		13	25	ns
^t PHL_	or CLK				25	40	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C. §Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
JM38510/30109BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30109BEA
JM38510/30109BEA.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30109BEA
JM38510/30109BFA	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30109BFA
JM38510/30109BFA.A	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30109BFA
M38510/30109BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30109BEA
M38510/30109BFA	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30109BFA
SN54LS109AJ	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS109AJ
SN54LS109AJ.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS109AJ
SN74LS109AD	Obsolete	Production	SOIC (D) 16	-	-	Call TI	Call TI	0 to 70	LS109A
SN74LS109ADR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS109A
SN74LS109ADR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS109A
SN74LS109AN	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS109AN
SN74LS109AN.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS109AN
SN74LS109ANE4	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS109AN
SN74LS109ANSR	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS109A
SN74LS109ANSR.A	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS109A
SNJ54LS109AJ	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54LS109AJ
SNJ54LS109AJ.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54LS109AJ
SNJ54LS109AW	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54LS109AW
SNJ54LS109AW.A	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54LS109AW

⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

PACKAGE OPTION ADDENDUM

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- (3) RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.
- (4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF SN54LS109A, SN74LS109A:

Catalog: SN74LS109A

Military: SN54LS109A

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS109ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS109ANSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS109ADR	SOIC	D	16	2500	340.5	336.1	32.0
SN74LS109ANSR	SOP	NS	16	2000	353.0	353.0	32.0

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
JM38510/30109BFA	W	CFP	16	25	506.98	26.16	6220	NA
JM38510/30109BFA.A	W	CFP	16	25	506.98	26.16	6220	NA
M38510/30109BFA	W	CFP	16	25	506.98	26.16	6220	NA
SN74LS109AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS109AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS109AN.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS109AN.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS109ANE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS109ANE4	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54LS109AW	W	CFP	16	25	506.98	26.16	6220	NA
SNJ54LS109AW.A	W	CFP	16	25	506.98	26.16	6220	NA

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